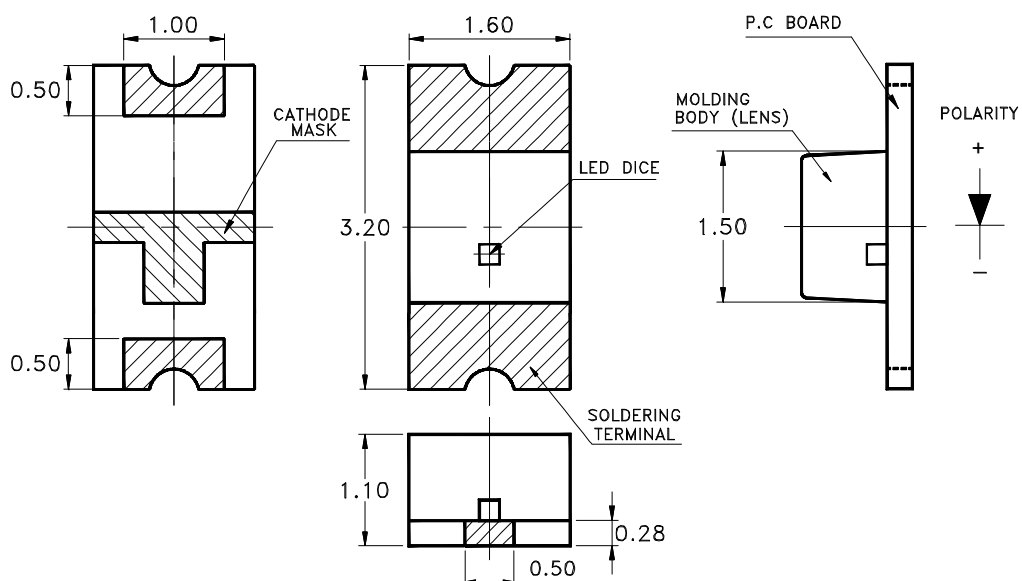


**Features**

- 3.2mm\*1.6mm SMT LED, Super thin (1.1H mm)
- Low Power Consumption
- Wide Viewing Angle
- Various Colors
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow and wave solder process.
- Meet ROHS Green Products
- Package: 3000pcs/Reel

**Applications**

- Backlight and Indicator

**Package Dimensions****Notes:**

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.2\text{mm}$  (.0079") unless otherwise noted.
3. Specifications are subject to change without notice
4. This drawing is only for reference, not as a basis for the actual structure.

**FSL-3216110F-RDBNC3****Selection Guide**

Part No	Lens Type	Dice	Emitted Color
FSL-3216110F-RDBNC3	Water Clear	AllnGap	Orange

**Electrical / Optical Characteristics At Ta=25°C**

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Condition
I <sub>v</sub>	Luminous Intensity	28	112		mcd	IF=20mA
2θ <sub>1/2</sub>	Viewing Angle		130		deg	IF=20mA
λ <sub>Peak</sub>	Peak Emission Wavelength		611		nm	IF=20mA
λ <sub>d</sub>	Dominant Wavelength		605		nm	IF=20mA
Δλ	Spectral Line Half-Width		17		nm	IF=20mA
V <sub>F</sub>	Forward Voltage	1.7	2.0		V	IF=20mA
I <sub>R</sub>	Reverse Current			10	uA	VR 5V

Note:

1. θ<sub>1/2</sub> is the angle from optical centerline where the luminous intensity is 1/2 optical centerline value**Absolute Maximum Ratings At Ta=25°C**

Parameter	Orange	Unit
Power Dissipation	75	mW
Peak Forward Current[1]	80	mA
Continuous Forward Current	30	mA
Dreading Linear From 25°C	0.4	mA/°C
Reverse Voltage	5	V
Electrostatic Discharge Threshold(HBM)	2000	V
Operating Temperature Range	-55°C to + 85°C	
Storage Temperature Range	-55°C to + 85°C	
Soldering Condition	260°C For 5 Seconds	

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width

Form No :

Rev : V.B2

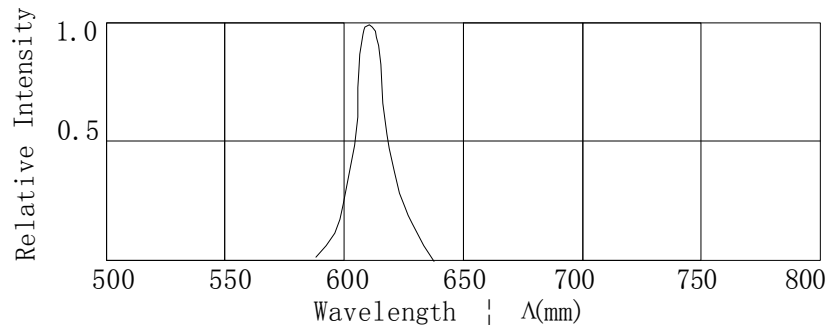
Page: 2 of 6

Approved By:

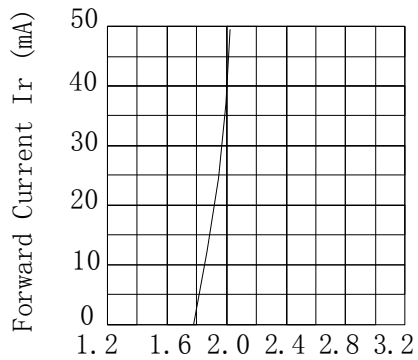
Prepared By:

Date:

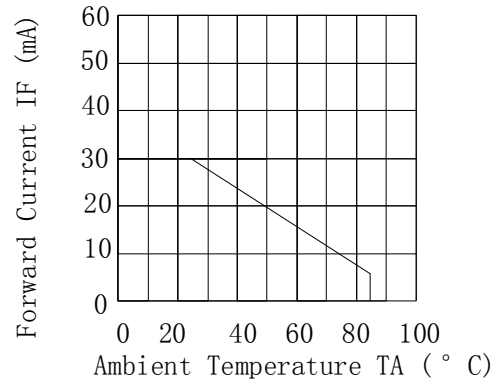
**Electrical Optical Characteristics Curves At Ta=25°C**



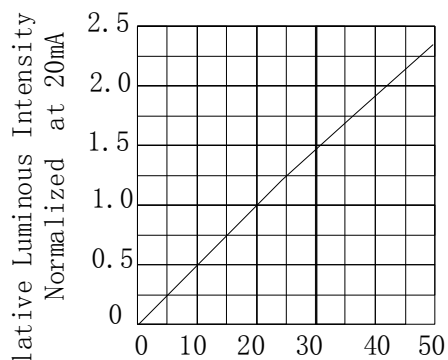
Relative Intensity vs. Wavelength



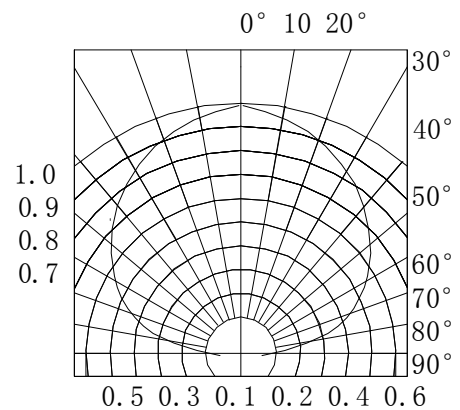
Forward Current VS. Forward Voltage



Forward Current Derating Curve



Relative Luminous Intensity VS. Forward Current



Spatial Distribution

**Bin Range Of Luminous Intensity**

Symbol	Bin Code	Min.	Max.	Unit	Condition
Iv	N	28	45	mcd	IF=20mA
	P	45	72		
	Q	72	112		
	R	112	180		
	S	180	280		

**Bin Range Of Forward Voltage**

Symbol	Bin Code	Min.	Max.	Unit	Condition
VF	V2	1.7	1.9	V	IF=20mA
	V3	1.9	2.1		
	V4	2.1	2.3		
	V5	2.3	2.5		

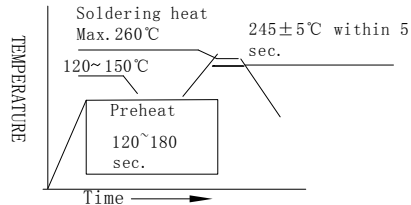
**Bin Range Of Dominate Wavelength**

Symbol	Bin Code	Min.	Max.	Unit	Condition
$\lambda d$	X	597	612	nm	IF=20mA

## Notes:

1. Tolerance of Luminous Intensity +/-20%
2. Tolerance of Forward Voltage +/-0.15V
3. Tolerance of the Dominate Wavelength +/- 2nm

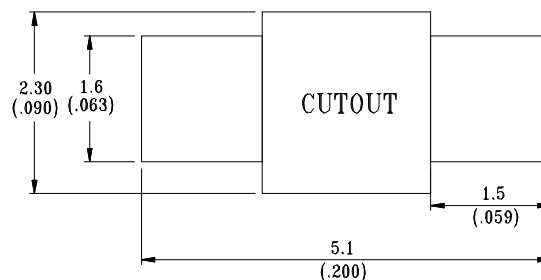
## SMT Reflow Soldering Instructions



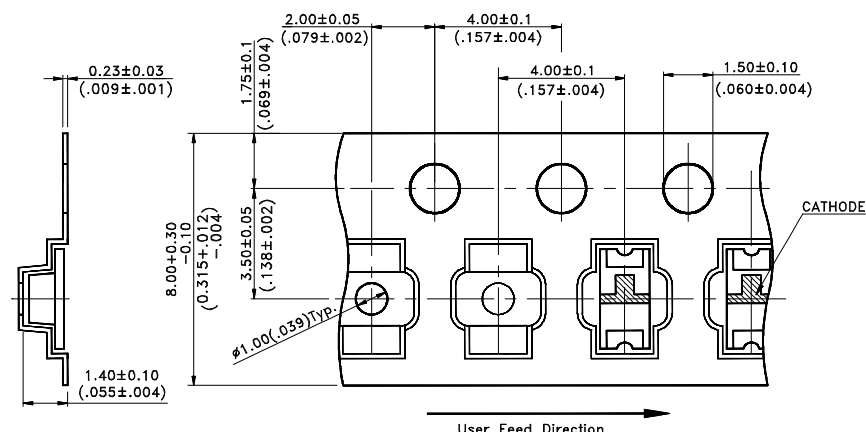
Notes:

1. Sells gives no other assurances regarding the ability of to withstand ESD. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
2. Reflow soldering should not be done more than two times.
3. Do not stress LED when soldering, and do not warp the circuit board after soldering
4. While using Iron, Power dissipation of Iron should be smaller than 25W, and temperature should be controllable. The work should be finished within 2 sec under 320°C for once only.

## Recommended Soldering Pad Dimensions



### Package Specifications (Units: mm (inches))



Notes:

1. The LEDs should be used within a year.
2. The LEDs should be kept in 5~30°C and 60% RH for less.
3. The LEDs should be used within 24 hours, or else should be kept a 5~30°C and 30% RH or less. And LEDs should be used within 7 days after opening the package.

**Reliability Test Items Conditions**

Classification	Test Item	Test Conditions	Test hours	Result
Endurance Test	Opertion Life	Connect with a power if=20mA Ta=Under room temperature	1000Hrs	0/20
	Hige Temperature High Humidity	Ta=+ 65℃±5℃ RH=90%-95%	240Hrs	0/20
	Hige Temperature Storage	High Ta=+ 85℃±5℃	1000Hrs	0/20
	Low Temperature Storage	Low Ta=-35℃±5℃ Test time=1000hrs	1000Hrs	0/20
Environmental Test	Temperature Cycling	-45℃～+105℃ 15min 5min 15min	300 Cycles	0/20
	Thermal Shock	-35℃～±5℃～+85℃～±5℃ 5min 10sec 5min	300 Cycles	0/20
	Solder Resistance	Preheating: 120℃-150℃,within 2 minutes. Operation heating : 260℃ (Max.),within5 seconds(Max.)	5Cycles	0/20

**Judgment criteria of failure for the reliability**

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V <sub>F</sub> (V)	I <sub>F</sub> =20mA	Over U×1.2
Rvevrse current	I <sub>R</sub> (μA)	V <sub>R</sub> =5V	Over U×2
Luminous intensity	I <sub>v</sub> (mcd)	I <sub>F</sub> =20mA	Below S×0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Measurment shall be taken between 2 hours after the test pieces have been returned to normal ambient conditions after completion of each test.